

TDS:EMIC

拓 電 半 導 體

自主封測 品質把控 售後保障

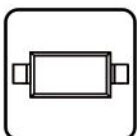
WEB | WWW.TDSEMIC.COM



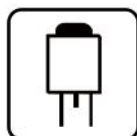
電源管理



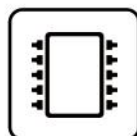
顯示驅動



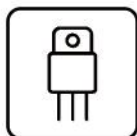
二三極管



LDO穩壓器



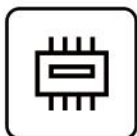
觸摸芯片



MOS管



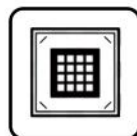
運算放大器



存儲芯片



MCU



串口通信

DB3-TD

產品規格說明書

BIDIRECTIONAL TRIGGER DIODE

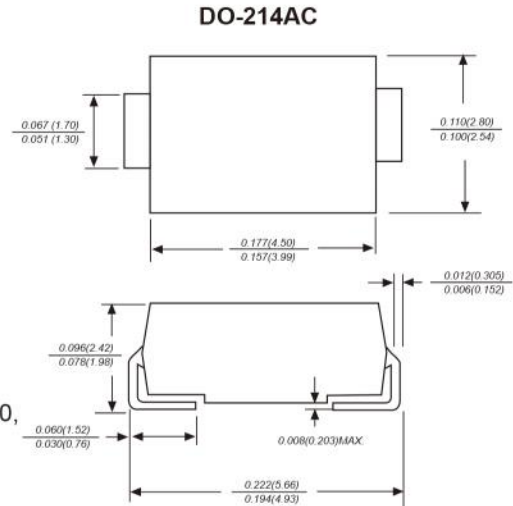
Reverse Voltage 28- 32 Volts Power: 150mW

FEATURES

The plastic package
VBO:28-36V version
Low breakover current
High temperature soldering guaranteed
250°C/10 seconds, 0.375" (9.5mm) lead length,
5 lbs. (2.3kg) tension

MECHANICAL DATA

Case: JEDEC DO-214AC plastic body
Terminals: Plated axial leads, solderable per MIL-STD-750,
Method 2026
Mounting Position: Any
Weight: DO-214AC 0.003 ounce, 0.093gram



Dimensions in inches and (millimeters)

MAXIMUM RATINGS AND CHARACTERISTICS

Ratings at 25°C ambient temperature unless otherwise specified.

	TEST CONDITION	SYMBOLS	VALUE			UNITS
			Min.	Typ.	Max.	
Breakover voltage *	C=22nF **	V _{BO}	28	32	36	VOLTS
Breakover voltage symmetry	C=22nF **	I+V _{BO} I-V _{BO} I	-3		3	VOLTS
Dynamic breakover voltage *	(NOTE 1)	I Δ V ± I	5			VOLTS
Output voltage *	DIAGRAM2	V _O	5			VOLTS
Breakover current *	C=22nF **	I _{BO}			100	μA
Rise time *	DIAGRAM3	t _r		1.5		μS
Leakage current *	V _R =0.5V _{BO}	I _B			10	μA
Power dissipation on printed circuit	T _A =65°C	P _d			150	mW
Repetitive peak on-state current	t _p =20μs f=100Hz	I _{TRM}			2	A
Thermal Resistances from Junction to ambient		R _{θJA}			400	°C/W
Thermal Resistances from Junction to lead		R _{θJL}			150	
Operating junction and storage temperature range		T _J , T _{STG}	-40		125	°C

* :Electrical characteristic appoicaboe in forward and reverse directions.

** :Connected in parallel with the devices.

Note 1:I_{BO} from I_{BO} to 10mA

RATINGS AND CHARACTERISTIC CURVES DB3-TD

DIAGRAM 1: CURRENT-VOLTAGE CHARACTERISTICS

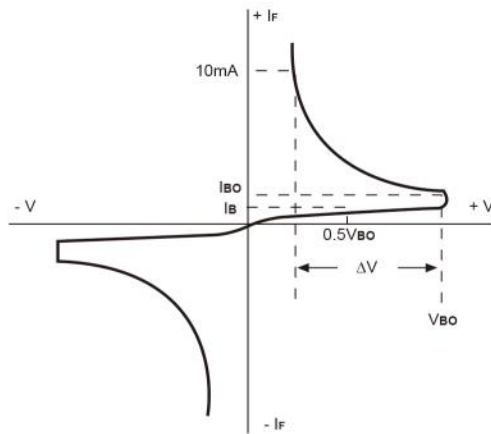


DIAGRAM 2: TEST CIRCUIT OUTPUT VOLTAGE

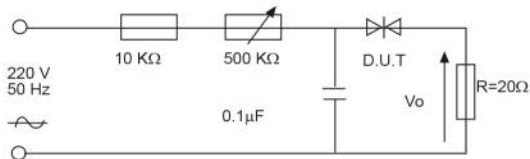


DIAGRAM 3: TEST CIRCUIT SEE DIAGRAM 2. ADJUST R FOR $I_P=0.5A$

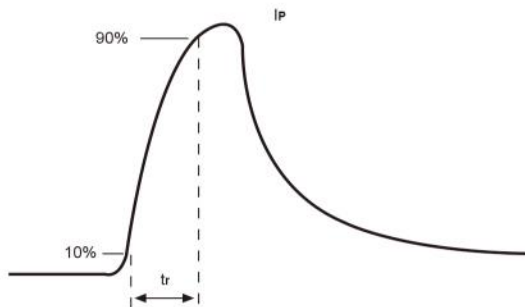


FIG. 1-POWER DISSIPATION VERSUS AMBIENT TEMPERATURE (MAXIMUM VALUES)

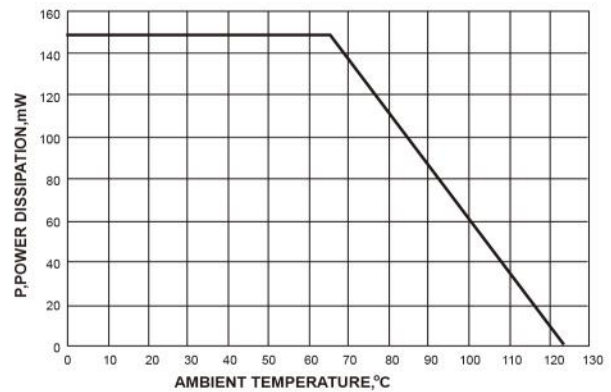


FIG. 2-PEAK PULSE CURRENT VERSUS PULSE DURATION (MAXIMUM VALUES)

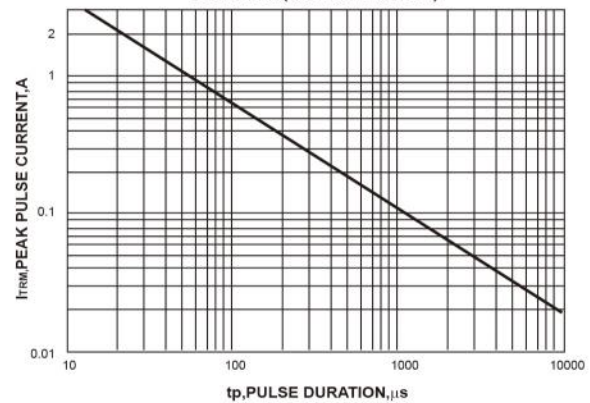


FIG. 3-RELATIVE VARIATION OF V_{Bo} VERSUS JUNCTION TEMPERATURE (TYPICAL VALUES)

